

# NC601E (Sn60/Pb40) NO CLEAN DELTA® SOLDER WIRE

CORPORATE HEADQUARTERS USA: 315 Fairbank St. Addison, IL • 630-628-8083 • FAX 630-628-6543

EUROPE UK: Unit 9 Apex Ct. Bassendale Rd. Bromborough, Wirral CH62 3RE • 44 151 334 0888 • FAX 44 151 346 1408

ASIA-PACIFIC HEADQUARTERS SINGAPORE: 6 Tuas South St. 5 Singapore 637790 • 65 6795 7757 • FAX 65 6795 7767

PHILIPPINES: Phase 1 Qualitek Ave. Mariveles, Bataan Philippines C-2106 • 6347 935 4163 • FAX 63475613717

CHINA: 3B/F, YiPa Print Bldg. 351 # JiHua Rd., Buji Shenzhen, China 518112 • 86 755 28522814 • FAX 86 755 28522787

This data is based on information that the manufacturer believed to be reliable and offered in good faith. Qualitek International, Inc. makes no warranties expressed or implied as to its accuracy and assumes no responsibilities and liabilities arising out of its use by others as conditions and methods of use of the products is beyond the control of Qualitek International, Inc. The user must determine the suitability of the product before using it on a commercial basis. The warranties extend only to the conformity of the product to the physical descriptions. In no event will Qualitek International, Inc. be responsible for special, incidental and consequential damages whether the claim is in contract, negligence or otherwise. Qualitek specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits.

#### **Description**

#### Flux Core

Delta® Solder Wire NC601E is a no clean, organic-based, cored solder wire that is available with both lead-containing alloys and lead-free alloys. NC601E contains purely organic acid activators so spreads rapidly and leaves minimal residue. NC601E exhibits virtually no spattering and conforms to IPC-J-STD-004B.

#### Main Features

- Excellent wettability
- Non-tacky residue
- Low spattering
- Available with both leaded and lead-free alloys

#### **Technical Data (Flux Extract)**

		~~·,			
	Specification	Test Method			
Color & Appearance	Light yellow solid	Visual			
Flux Classification	ORL0	IPC-J-STD-004B			
Copper Mirror	No removal of copper film	IPC-TM-650 2.3.32			
Corrosion	Pass	IPC-TM-650 2.6.15			
SIR	>1 x 10 <sup>8</sup> ohms	IPC-TM-650 2.6.3.3			
Post Reflow Flux Residue	55%	TGA Analysis			
Acid Value	280 - 320	IPC-TM-650 2.3.13			
Flux Residue Dryness	Pass	IPC-TM-650 2.4.47			
Spitting of Flux-Cored Solder	0.3%	IPC-TM-650 2.4.48			
Solder Spread	100 mm <sup>2</sup>	IPC-TM-650 2.4.46			

## Wire Diameter

Sn60/Pb40 NC601E Delta Solder Wire is available in a variety of diameters. The chosen diameter is based on application methods, pad size, and desired solder joint volume. Generally, the diameter of the wire should be slightly larger than the width/diameter of the joint or connection to be soldered. Below is a list of standard diameters.

#### Standard wire diameters

Diamter/Inch	0.125	0.092	0.062	0.050	0.040	0.032	0.028	0.025	0.020	0.015
Diameter/mm	3.18	2.33	1.57	1.27	1.01	0.81	0.71	0.63	0.51	0.38
Std.Wire	11	13	16	18	19	21	22	23	25	28
Gauge Tolerance, in.	+/-0.006	+/-0.005	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002

#### Flux Percentage

Qualitek utilizes a state-of-the-art automatic wire extrusion and wire drawing machines to manufacture consistent solder. The introduction of flux core in the wire extrusion process involves continual monitoring of flux percentage to ensure minimal flux voids and irregular wire. Typical flux percentage for leaded solder is 1.1 – 3.3%.

### **Physical Properties**

# **Solder Composition**

Qualitek® has developed an organic-based core flux with alloy composition, Sn60/Pb40. Qualitek Sn60/Pb40 alloy conforms to and exceeds the impurity requirements of IPC-J-STD-006C.

Typical Analysis													
Sn	Pb	Ag	Al	As	Au	Bi	Cd	Cu	Fe	In	Ni	Sb	Zn
59.5 -60.5	Bal	0.100 Max	0.005 Max	0.030 Max	0.050 Max	0.100 Max	0.002 Max	0.080 Max	0.020 Max	0.100 Max	0.010 Max	0.200 Max	0.003 Max

	Sn60/Pb40
Melting Point, °C	183 - 188
Hardness, Brinell	16 HB
Coefficient of Thermal Expansion	23.9
Tensile Strength, kgf/cm <sup>2</sup>	535
Tensile Elongation, %	40
Density, g/cm <sup>3</sup>	8.50
Electrical Resistivity, (μΩ-cm)	15.3
Thermal Conductivity, W/m-K	49

# Flux Residues & Cleaning

NC601E is a no clean formulation; therefore, the residues do not need to be removed for typical applications. If residue removal is desired, the use of Everkleen 1005 Buffered Saponifier with a 5-15% concentration in hot 60 °C (140 °F) de-ionized water will aid in residue removal.

#### **Storage & Shelf Life**

Solder wire storage should be in a 65-80 °F environment away from direct heat. We recommend using gloves when handling solder wire directly. Solder wire has an indefinite shelf life.

#### **Packaging**

Qualitek flux-core wire and solid wire are packed in

12.5lb -box of ½ lb spools 25 lb -box of 1 lb spools 12.5kg -box of ½ kg spools 8 kg -box of 1kg spools 40 lb -box of 5 lb spools 20 lb -box of 20 lb spools

#### **Disposal**

Sn60/Pb40 NC601E leaded solder wire should be disposed of according to all local, regional, national and international regulations.

Qualitek® and Delta® are brands of Qualitek International, Inc. For Health and Safety information refer to Safety Data Sheet.